



A Silicom Company

fbC2CGg3hl supporting the fbCapture framework

NETWORK INTERFACE

- IEEE standard: IEEE 802.3 10GE, 40GE, 25GE, 100GE
- Physical interface: 2 x QSFP28 slots
- 10GE and 25GE supported through break-out cable assemblies
- Supported QSFP28 modules (25GE/100GE)
 - SR4, LR4, PSM4 /IR4, CWDM4/CLR4, CR4 (DAC), ER4
 - Appropriate 4x25GE Break-out modules
- Supported QSFP+ modules (10GE/40GE)
 - SR4, LR4, PSM4, CWDM4, ER4, ZR4 BiDi (850 nm) CR4 (DAC)
 - Appropriate 4x10GE Break-out modules
- Ethernet PHY directly embedded in FPGA

HOST INTERFACE

- Physical bus connector: 16 lane PCIe.
- PCIe bus type: 16 lane PCIe Gen3 (2x8 via bifurcation)
- Optional 2nd PCIe cable connector
 - Extra 16 lane PCIe Gen3 to host (2x8 via bifurcation)
 - Card interconnect (release TBD)
 - Cost optimized variant - 2nd connector with 12 lanes 1x8+1x4
- PCIe compliant
- Multiple logical channels for DMA to host or egress to physical output ports

ON BOARD MEMORY

- On-board buffering for application robustness
- 16GB DDR4

PERFORMANCE

- Capture rate (bursts): Line rate
- Capture rate (sustained): Line rate
- Transmission rate (selective bypass): Line rate
- Transmission rate (daisy chain): Line rate

LATENCY

- Less than 3.2 μ s to host memory
- Less than 3.2 μ s from host memory to Tx
- Non-blocking sending, allowing user applications to operate independently

TIME STAMPING AND SYNC

- Resolution = 3.1 ns
- Accuracy down to 20 n.
- Daisy chain PPS internally between multiple cards
 - Via COAX or Card interconnect adapter
- PPS synchronization via SMA connector
- Optional PTP IEEE 1588-2008 RJ45 via secondary supporting card

CONFIGURATION

- Dual boot images with automatic fallback to fail-safe image
- Full firmware upgrades via supplied tools or fbCAPTURE API

ENVIRONMENT

- Physical dimensions: ½ length, standard height
- PCIe: 111 x 167 mm
- Weight: 270g
- Operating temperature: 0 – 55°C, 30 – 130°F
- Power consumption: est. 48W
- Optional auxiliary power
- Operating humidity: 20 – 80%
- Hardware compliance: RoHS, CE
- Passive cooling available, requires adequate host system airflow
- Active cooling solution available

ADDITIONAL CARD SUPPORT

- fbCAPTURE API
- On-board temperature sensor
- On-board multi-color status LED
- Link and Activity LED for ports

CARD VARIANTS

- All card variants have FPGAs optimized for resource requirements of the varying link types.
Available models:
 - fbC2CGg3hl for 10/40/25/100GE
 - fbC2CGg3hl-2x40 for 40GE, cost optimized
 - fbC2CGg3hl-8x10 for 10GE, cost optimized
- Mixed speed models can be customized, eg. 1x100GE + 4x25GE

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Dedication to Performance

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